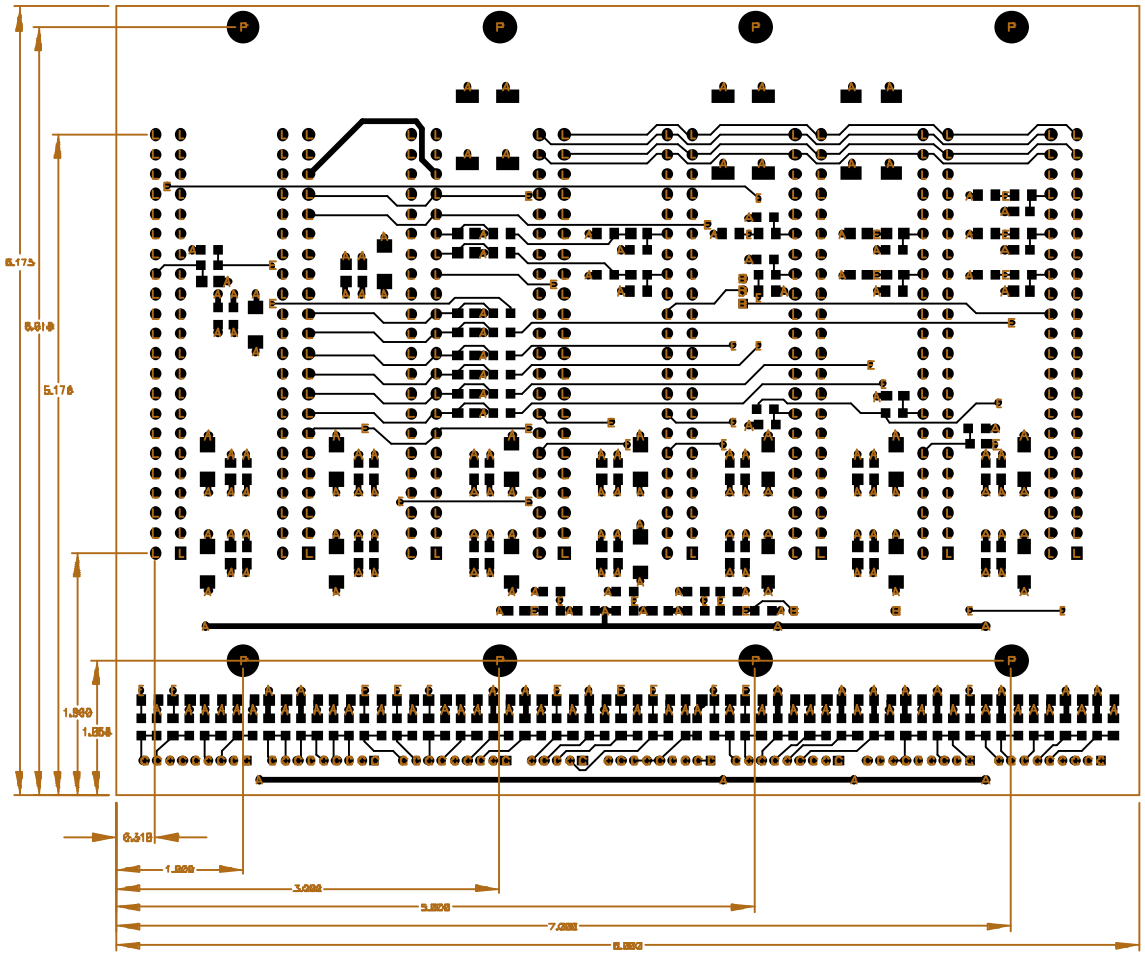

NOTES: UNLESS OTHERWISE SPECIFIED –

1. INTERPRET DRAWING PER MIL–STD–100.
2. BOARDS TO BE FREE OF FRAYED AND SHARP EDGES.
3. N/A
4. FABRICATE PER IPC–A–600, CLASS 2.
5. MATERIAL: LAMINATED GLASS EPOXY SHEET, COPPER CLAD PER MIL–P–13949F, GFN 0930 C01/01A1A.
6. COPPER PLATE THE CONDUCTIVE PATTERN TO A SURFACE THICKNESS OF .001 MIN.
7. SOLDERMASK OVER BARE COPPER BOTH SIDES OF THE PCB USING LPI; COLOR: GREEN.
8. IMAGE PATTERN TO DRILL PATTERN REGISTRATION SHALL BE WITHIN .005.
9. SILKSCREEN COMPONENT SIDE USING A PERMANENT NON–CONDUCTIVE INK. COLOR: WHITE.
10. MARK VENDOR ID, DATE, AND/OR LOT CODE ON SOLDER SIDE OF BOARD.

Drill Table				
Hole Dia (inch)	Symbol	Quantity	Plated	Tol
0.018	E	48	Yes	+/–.003
0.028	A	207	Yes	+/–.003
0.037	B	5	Yes	+/–.003
0.045	C	68	Yes	+/–.003
0.055	L	352	Yes	+/–.003
0.166	P	8	Yes	+/–.003